ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INCLUSTRIES®	. Bannockh	ourn, Illinois, A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su	bstances v all lower	vithin the manufactu level materials for v	urer listed which the	item. Note: nanufacture	if the item is an as or has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and N	als and Mfg Information			
Supplier Information														
Company name* Company unique II			ique ID	le ID Unique			nique ID Authority				Response Date*			
onsemi										2023-0	2023-06-08			
Contact Name	act Name Title - Contact					Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards Product Enviro Compl			ro Compliance	Compliance		NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			sentative	ve !		Phone - Representative*			Email ·	Email - Representative*				
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		ber Mfr Item Name			Effective Date	Version	Μ	Manufacturing Site		Weight*	UOM	Unit Type	
	MMBD3	MMBD301M3T5G SS SCHOTTKY D		DIODE		2023-06-08		C	CN1		1.275	mg	Each	
Aanufacturing Proccess Informatio	n		·									·		
Terminal Plating / Grid Array Mater	rial T	al Terminal Base Alloy J-		J-STD-020 MSI	L Rating	Peak Process Body Temper		emperature	ture Max Time at Peak Tem		ture Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperature	during sol	Idering is 10-3	0 seconds											
or more information regarding material co														

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.13	mg	Supplier	Silicon (Si)	7440-21-3		0.13	mg	
Lead Frame	0.28	mg	Supplier	Silver (Ag)	7440-22-4		0.0255	mg	
			В	Nickel (Ni)	7440-02-0		0.103	mg	
			Supplier	Iron (Fe)	7439-89-6		0.1414	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0101	mg	
Mold Compound-Black	0.86	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.086	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0043	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1247	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.559	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.086	mg	
Plating	0.003	mg	Supplier	Tin (Sn)	7440-31-5		0.003	mg	
Wire Bond - Cu	0.002	mg	Supplier	Copper (Cu)	7440-50-8		0.002	mg	